

## 10/567103 IAP9 Rec'd PCPPTO 03 FEB 2006'

Form PTO-1449 (REV. I/06)		US Dept. of Commerce PATENT & TRADEMARK OFFICE		ATTY DOCKET NO. 126918			APPLICATION NO. New U.S. National Stage of	
INFORMATION DISCLOSURE STATEMENT							PCT/GB2004/003402	
(Use several sheets if necessary)				APPLICANTS Magdalena LEWICKA-SCHAFER				
•				FILING DATE February 3, 2006			GROUP	
U.S. PATENT DOCUMENTS								
Examiner Initials	Cite No.	Document Number	Date		Name			
/AC/	1	US 2003/0084584 A1	5/8/2003		OSTERSTOCK			
	2	US 5,075,130	12/24/1991		REEBER et al.			
	3	US 5,422,322	6/6/1995		CHEN et al:			
	4	US 4,153,998	5/15/1979		MCMURTRY			
	5	US 4,084,323	4/18/1978		MCMURTRY			
	6	US 5,656,563	8/12/1997		CHEN et al.			
/AC/	7	US 5,976,429	11/2/1999		CHEN et al.			
FOREIGN PATENT DOCUMENTS								
Examiner Initials	Cite No.	Document Number	D	ate	Country		With English Abstract	With English Translation
/AC/	8	EP 1 079 201 A2	2/28/2001		EUROPE			
]	9	DE 202 07 100 U I	9/5/2002		GERMANY		·	
	10	EP 0 620 252 A1	10/19/1994		EUROPE			
	11	WO 03/039233 A2	5/15/2003		WIPO			
	12	GB 2 243 688 A	11/6/1991		GREAT BRITAIN			
/AC/	13	EP 0 746 532 B1	9/15/1999		EUROPE			
OTHER DOCUMENTS								
Examiner Initials	Cite No.	(Including Author, Title, Date, Pertinent Pages, etc.)						
/AC/	14	KUSUNOSE et al., "Machinability of Silicon Nitride/Boron Nitride Nanocomposites," Journal of the American Ceramic Society,						
		vol. 11, no. 85, pp. 2689-2695, XP001141572 (November 2002)						
/AC/	15	KUSUNOSE et al., "Fabrication and Microstructure of Silicon Nitride/Boron Nitride Nanocomposites," Journal of the American						
		Society, vol. 85, no. 11, pp. 2678-2688 (November 2002)						
/AC/	16	ERDEMIR et al., "Self-Replenishing Solid Lubricant Films on Boron Carbide," Surface Engineering, vol. 15, no. 4, pp. 291-						
		295 (1999)						
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EXAMINER /Amy Cohen/						date considered 03/30/2007		
Examiner: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.								

Date: February 3, 2006